

ABSTRACT**AL WIRING MATERIAL**

There is provided an Al wiring material which
5 suppresses a chip crack and achieves thermal shock
resistance while suppressing lowering of a yield at the
time of manufacture. The Al wiring material contains at
least Sc and Zr so as to satisfy $0.01 \leq x_1 \leq 0.5$ and $0.01 \leq$
 $x_2 \leq 0.3$ where x_1 is a content of Sc [% by weight] and x_2
10 is a content of Zr [% by weight], with the balance
comprising Al.

[No figure]